MAR 0.8 2004

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

in re Patent Application of

Hideo ARIKAWA et al.

Application No.: 10/088,996

Filed: March 26, 2002.

For: AQUEOUS DISPERSION

COMPOSITION FOR IMPARTING

CHIPPING RESISTANCE

MAIL STOP AFTER FINAL

Group Art Unit: 1713

Examiner: Rip A. Lee

Confirmation No.: 8985

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REPLY AND AMENDMENTS PURSUANT TO 37 C.F.R. §1.116

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

In response to the Office Action [Final Rejection] mailed December 12, 2003, please amend the above-identified patent application as follows: